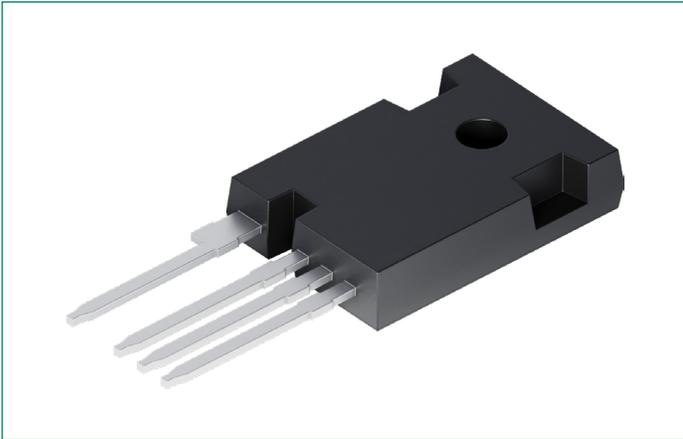


IXSH100N120L3KHV

1200 V, 21 mΩ, 102 A SiC MOSFET

HF 

Features

- 3rd Generation SiC MOSFET Technology with -3.5/+15...18 V gate drive
- High blocking voltage with low on-state resistance
- High-speed switching with low capacitance
- 175 °C operating junction temperature capability
- Ultra-fast and robust intrinsic body diode
- Kelvin source contact

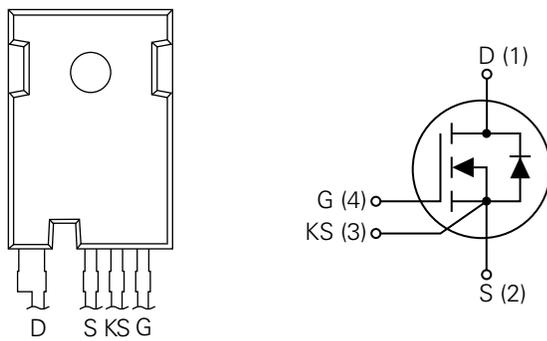
Applications

- Motor drives
- EV charging infrastructure
- DC/DC converter
- Switch mode power supplies
- Solar inverters

Product Summary

Characteristic	Value	Unit
V_{DSS}	1200	V
$R_{DS(on)}$	21	mΩ
$I_D @ 25\text{ °C}$	102	A

Pinout Diagram (TO-247-4L)



D: Drain; **G:** Gate; **KS:** Kelvin Source; **S:** Source

Maximum Ratings ($T_c = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value	Unit
V_{DSS}	Drain-source voltage	$V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$	1200	V
V_{GSM}	Maximum gate-source voltage	Static (DC)	-5 to +20	V
	Transient gate-source voltage	Pulse width < 200 ns, D < 1%	-10 to +23	
I_D	Drain current (continuous) Fig.23	$V_{GS} = 18\text{ V}, T_c = 25\text{ °C}$	102	A
		$V_{GS} = 18\text{ V}, T_c = 100\text{ °C}$	73	A
I_{DM}	Peak drain current Fig. 25, 26	Pulse width limited by SOA	255	A
I_{SM}	Diode pulsed forward current Fig. 25, 26	Pulse width limited by SOA and dynamic $R_{th(j-c)}$	255	A
P_{tot}	Total power dissipation Fig. 24	$T_c = 25\text{ °C}$	405	W
T_{vj}	Virtual junction temperature range	-	-55 to +175	°C
T_{stg}	Storage temperature range	-	-55 to +175	°C
T_{sold}	Soldering temperature	Wave soldering only allowed at leads, 1.6 mm from case for 10 s	260	°C

Recommended Values

Symbol	Characteristic	Value			Unit
		Min.	Typ.	Max.	
V_{GSon}	Recommended turn-on voltage	15	-	18	V
V_{GSoff}	Recommended turn-off voltage	-3.5	-	-2	

Thermal Characteristics

Symbol	Characteristic	Value			Unit
		Min.	Typ.	Max.	
$R_{th(j-c)}$	Thermal resistance from junction to case Fig. 25	-	0.37	-	K/W

Electrical Characteristics – Static ($T_c = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
I_{DSS}	Drain-source leakage current	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$	-	5	100	μA
I_{GSS}	Gate leakage current	$V_{DS} = 0\text{ V}, V_{GS} = -5 \sim 20\text{ V}$	-	-	± 100	nA
$V_{GS(th)}$	Gate threshold voltage Fig. 8, 9	$V_{GS} = V_{DS}, I_D = 13\text{ mA}$	2.0	2.7	4.0	V
		$V_{GS} = V_{DS}, I_D = 13\text{ mA}, T_{vj} = 175\text{ °C}$	-	2.0	-	
$R_{DS(on)}$	Drain-source on-state resistance Fig. 4, 5, 6, 7	$V_{GS} = 18\text{ V}, I_D = 40\text{ A @ } T_{vj} = 25\text{ °C}$	-	21	273	m Ω
		$V_{GS} = 18\text{ V}, I_D = 40\text{ A @ } T_{vj} = 175\text{ °C}$	-	34.8	-	
		$V_{GS} = 15\text{ V}, I_D = 40\text{ A @ } T_{vj} = 25\text{ °C}$	-	25.3	-	
		$V_{GS} = 15\text{ V}, I_D = 40\text{ A @ } T_{vj} = 175\text{ °C}$	-	36.9	-	

Electrical Characteristics – Dynamic ($T_{vj} = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit	
			Min.	Typ.	Max.		
C_{iss}	Input capacitance Fig. 16	$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V},$ $f = 100\text{ kHz}, V_{AC} = 25\text{ mV}$	–	3450	–	pF	
C_{oss}	Output capacitance Fig. 16		–	146	–		
C_{rss}	Reverse transfer capacitance Fig. 16		–	8	–		
E_{oss}	C_{oss} stored energy Fig. 17		–	61.5	–		μJ
Q_G	Total gate charge Fig. 18	$V_{DS} = 800\text{ V}, I_D = 40\text{ A},$ $V_{GS} = -3\text{ to }+18\text{ V}$	–	130	–	nC	
Q_{GS}	Gate-source charge Fig. 18		–	56	–		
Q_{GD}	Gate-drain charge Fig. 18		–	44	–		
$R_{g(int)}$	Gate input resistance	$f = 1\text{ MHz}$	–	2.85	–	Ω	
E_{on}	Turn-on switching energy Fig. 19, 20	$V_{DS} = 800\text{ V}, I_D = 60\text{ A},$ $V_{GS} = -3.5\text{ to }+18\text{ V},$ $R_{G(ext)} = 2.0\text{ Ω}, L = 100\text{ μH}$	$T_{vj} = 25\text{ °C}$	–	750.4	–	μJ
			$T_{vj} = 175\text{ °C}$	–	1067.3	–	
E_{off}	Turn-off switching energy Fig. 19, 20, 22		$T_{vj} = 25\text{ °C}$	–	183.2	–	μJ
			$T_{vj} = 175\text{ °C}$	–	212.3	–	
$t_{d(on)}$	Turn-on delay time Fig. 19, 20		$T_{vj} = 25\text{ °C}$	–	6.1	–	ns
t_r	Rise time Fig. 19, 20		$T_{vj} = 25\text{ °C}$	–	24.5	–	
$t_{d(off)}$	Turn-off delay time Fig. 19, 20		$T_{vj} = 25\text{ °C}$	–	20.5	–	
t_f	Fall time Fig. 19, 20		$T_{vj} = 25\text{ °C}$	–	8.4	–	

Reverse Diode Characteristics ($T_{vj} = 25\text{ °C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
V_{SD}	Diode forward voltage Fig. 10, 11, 12	$I_{SD} = 40\text{ A}, V_{GS} = 0\text{ V}$	–	4.2	–	V
		$I_{SD} = 40\text{ A}, V_{GS} = 0\text{ V}, T_{vj} = 175\text{ °C}$	–	4.1	–	V
I_s	Diode forward current (continuous)	$V_{GS} = -2\text{ V}, T_c = 25\text{ °C}$	–	–	75	A
		$V_{GS} = -2\text{ V}, T_c = 100\text{ °C}$	–	–	43	
t_{rr}	Reverse recovery time	$V_{GS} = -3.5\text{ V}/+18\text{ V}, I_{SD} = 60\text{ A}, V_R = 800\text{ V},$ $R_{G(ext)} = 12\text{ Ω}, L = 100\text{ μH}, di/dt = 3000\text{ A}/\mu\text{s}$	–	41.5	–	ns
Q_{rr}	Reverse recovery charge		–	281	–	nC
I_{rrm}	Peak reverse recovery current		–	24.9	–	A

Characteristic Curves

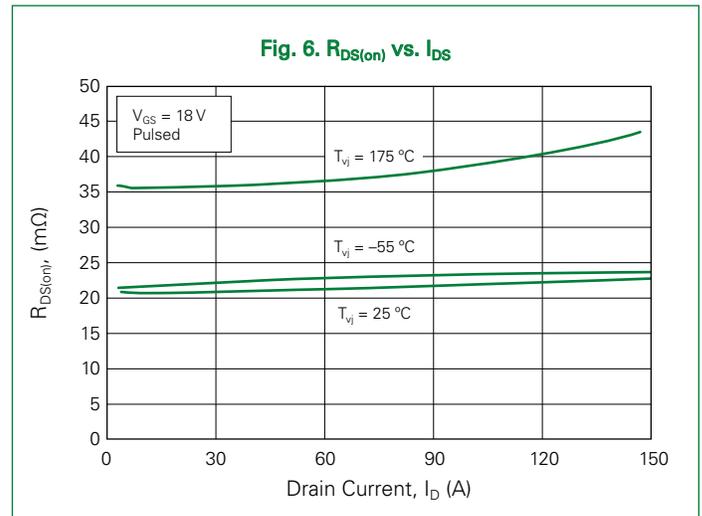
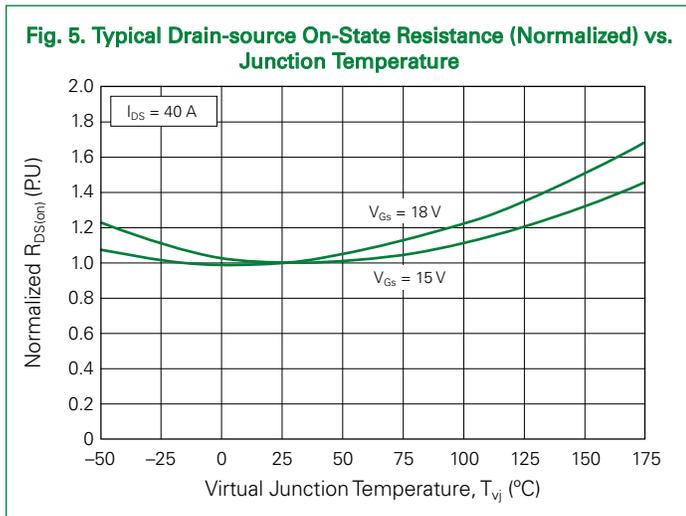
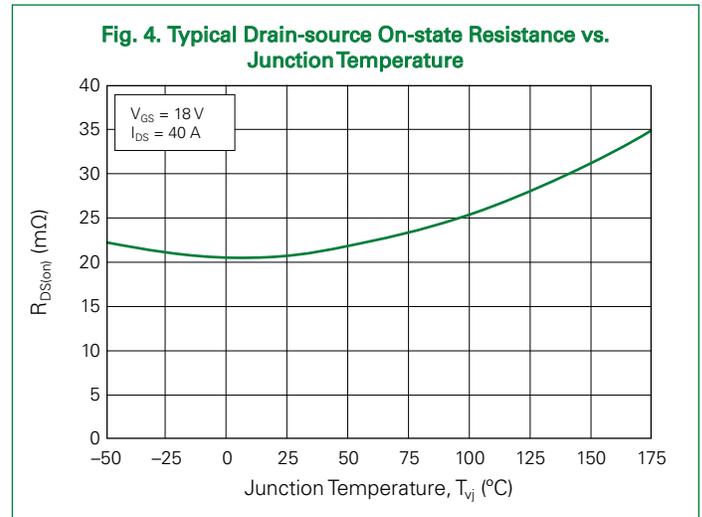
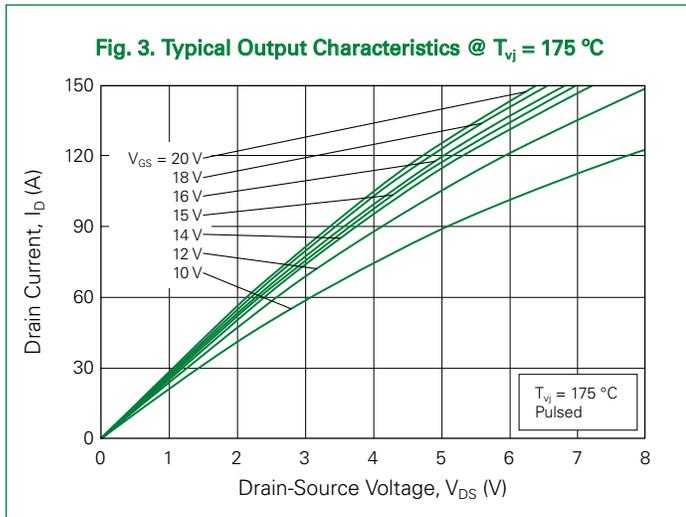
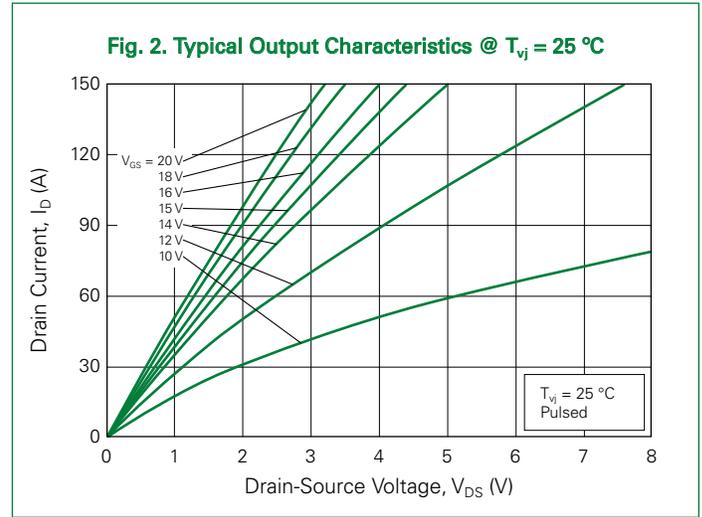
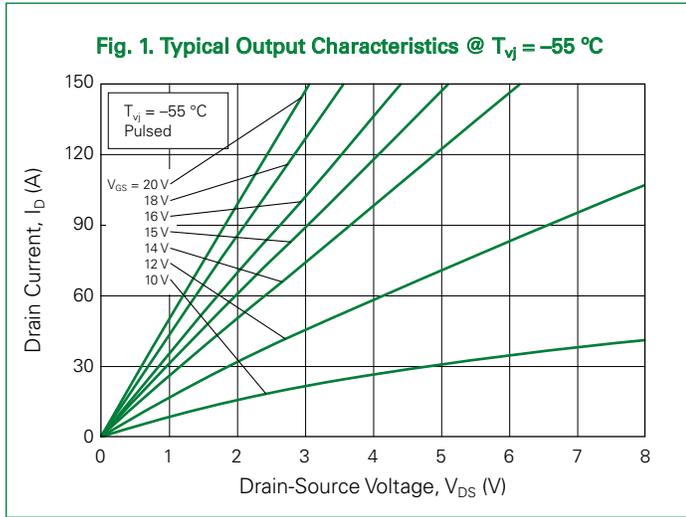


Fig. 7. $R_{DS(on)}$ vs. Temperature

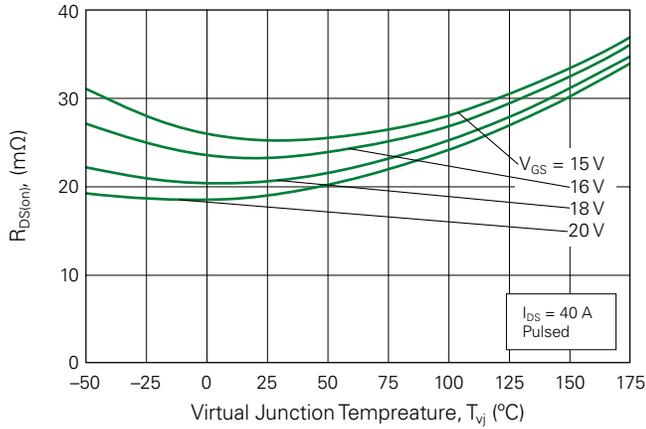


Fig. 8. Transfer Curves

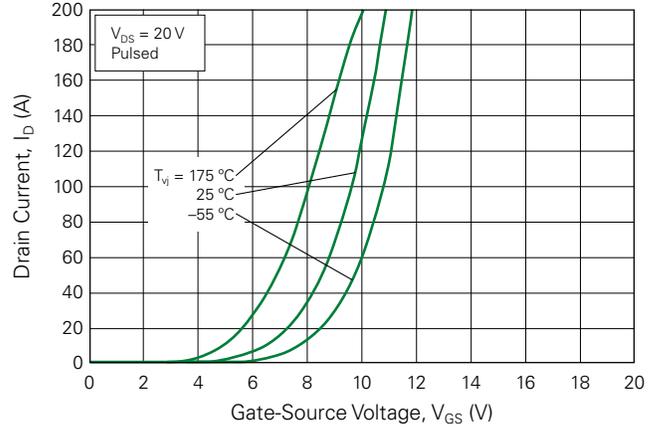


Fig. 9. Threshold Voltage vs. Temperature

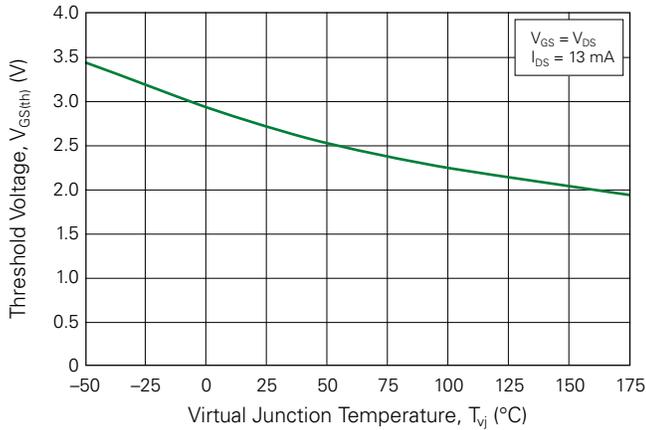


Fig. 10. Body Diode Curves @ $T_{vj} = -55$ °C

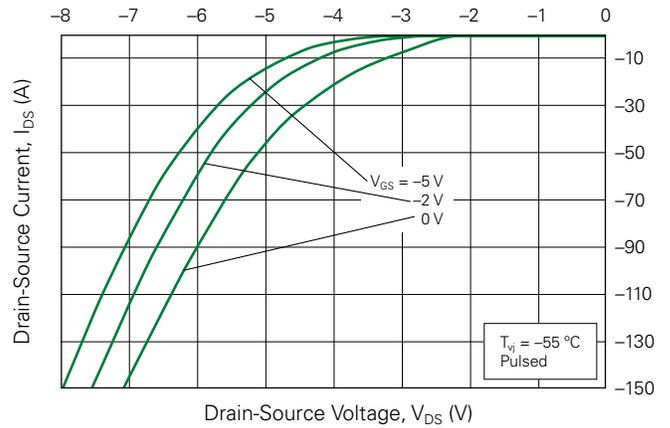


Fig. 11. Body Diode Curves @ $T_{vj} = 25$ °C

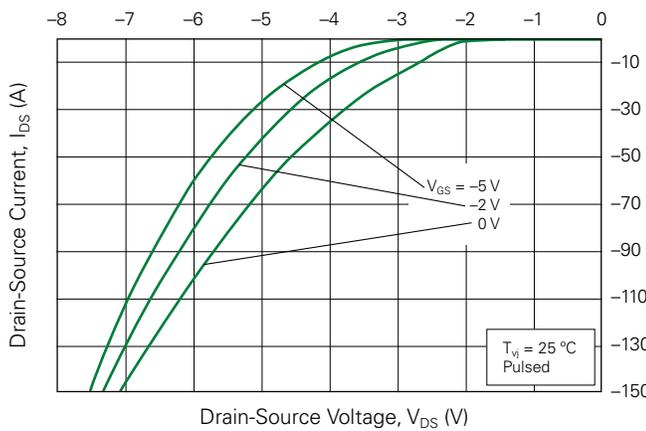


Fig. 12. Body Diode Curves @ $T_{vj} = 175$ °C

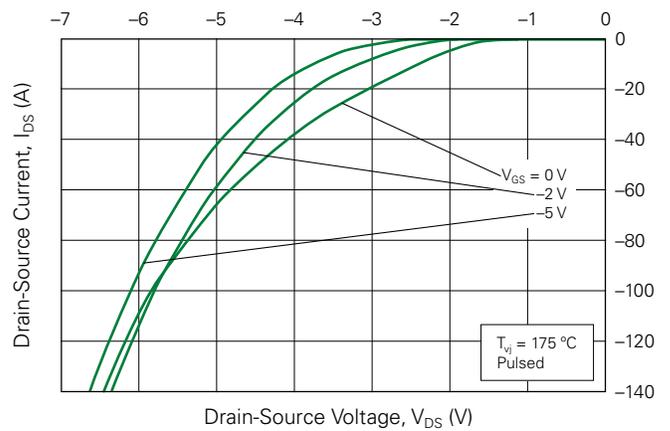


Fig. 13. 3rd Quadrant Curves @ $T_{vj} = -55\text{ }^{\circ}\text{C}$

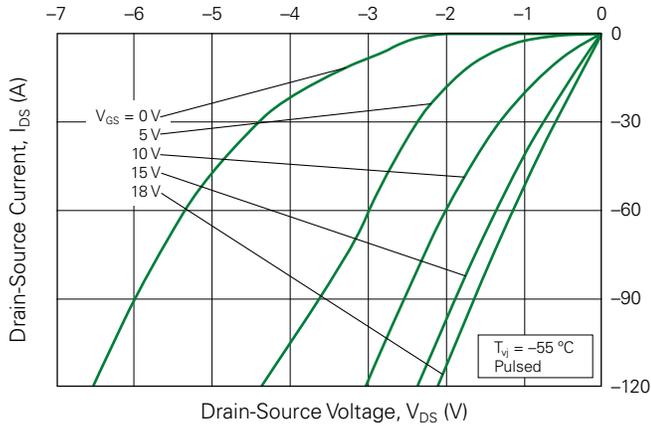


Fig. 14. 3rd Quadrant Curves @ $T_{vj} = 25\text{ }^{\circ}\text{C}$

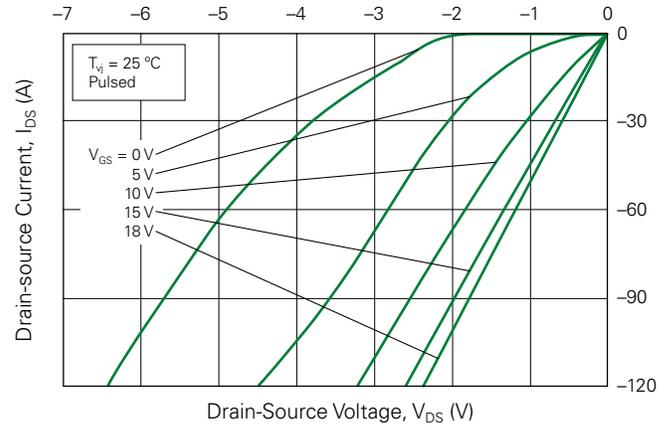


Fig. 15. 3rd Quadrant Curves @ $T_{vj} = 175\text{ }^{\circ}\text{C}$

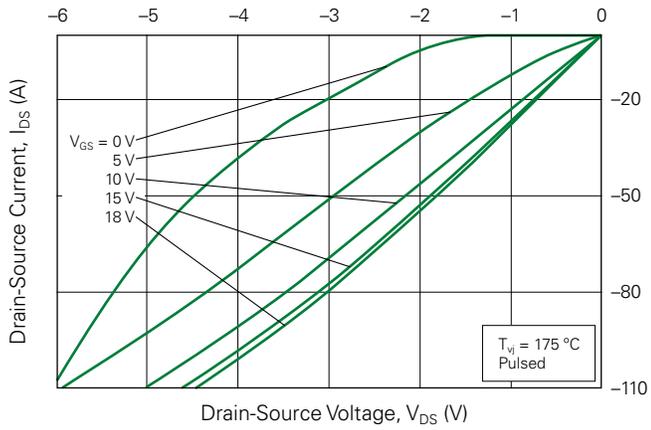


Fig. 16. Capacitance vs. V_{DS}

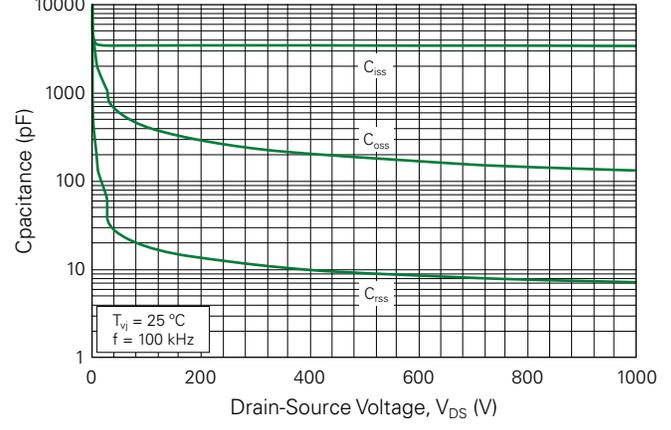


Fig. 17. Output Capacitor Stored Energy

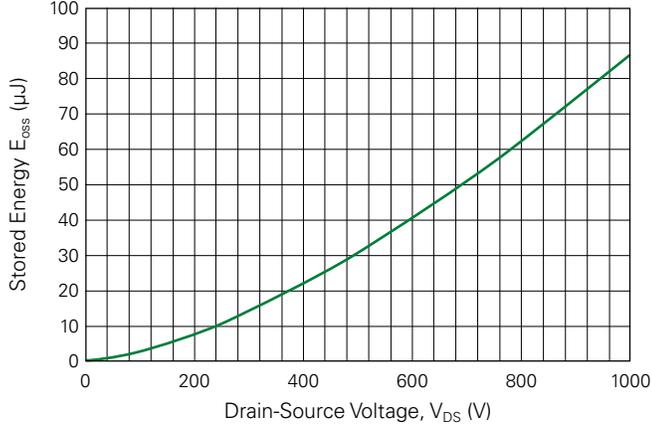


Fig. 18. Gate Charge Characteristics

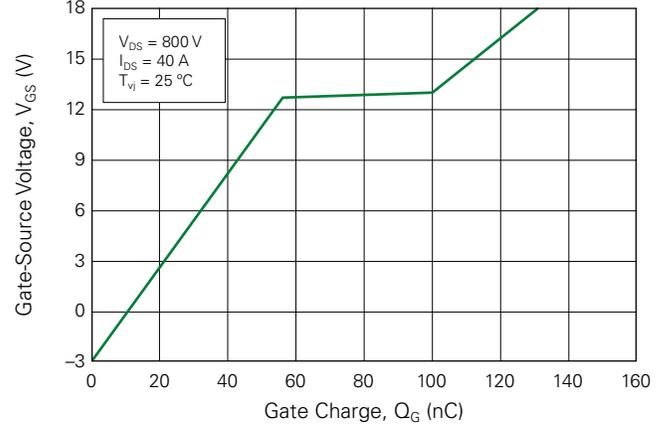


Fig. 19. Switching Energy vs. $R_{G(ext)}$

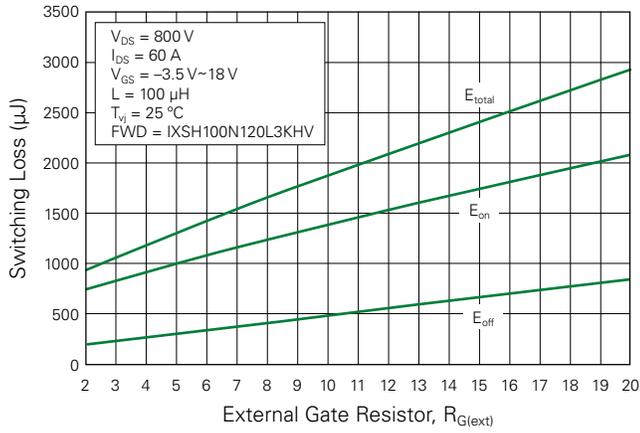


Fig. 20. Switching Times vs. $R_{G(ext)}$

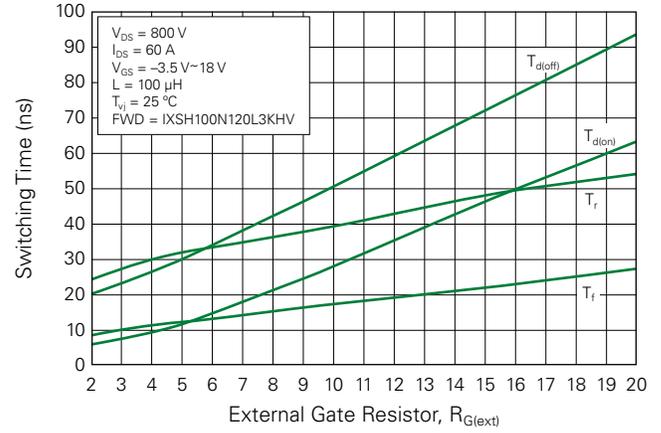


Fig. 21. Switching Energy vs. I_{DS}

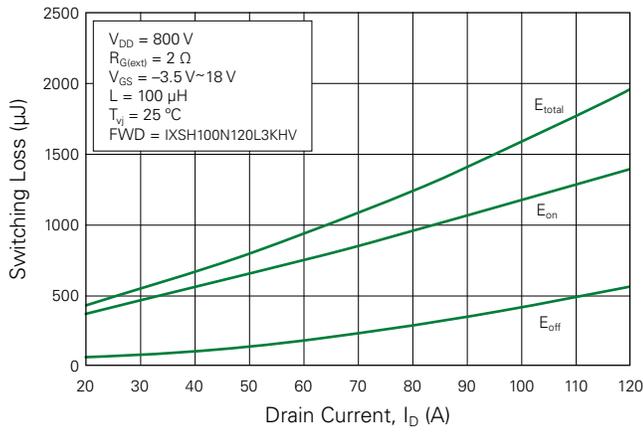


Fig. 22. Switching Energy vs. Temperature

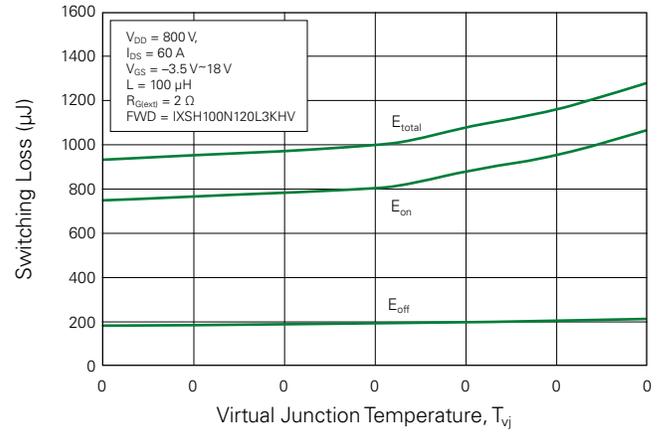


Fig. 23. Continuous Drain Current vs. Case Temperature

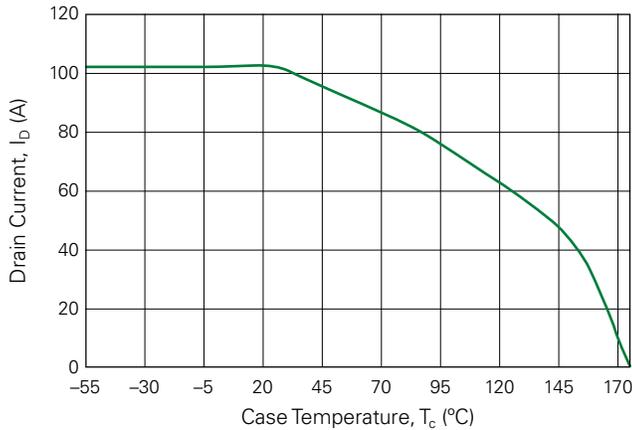


Fig. 24. Max. Power Dissipation Derating vs. Case Temperature

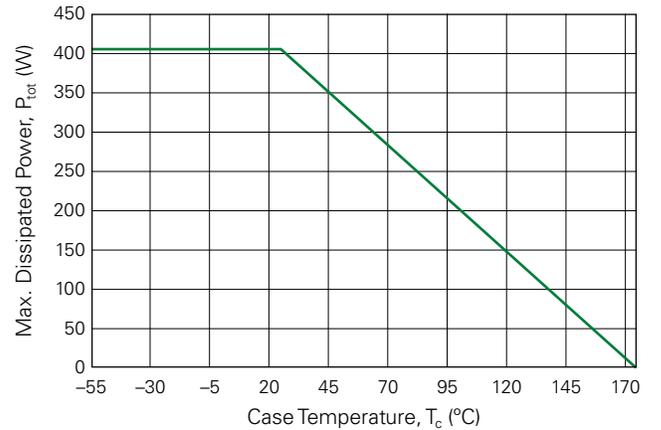


Fig. 25. Thermal Impedance

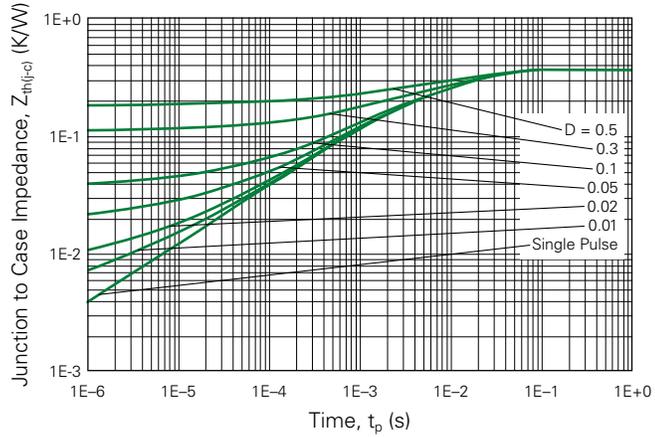
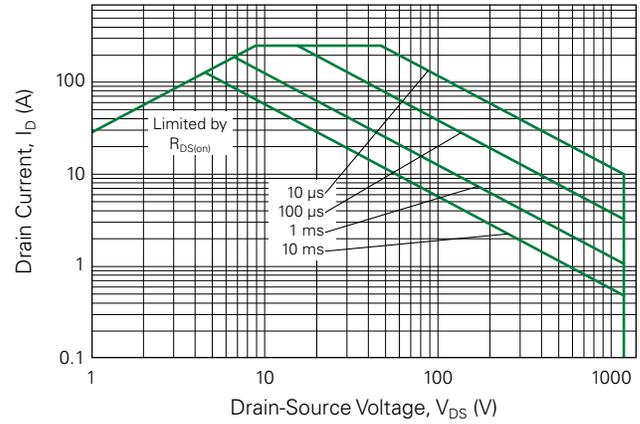


Fig. 26. Safe Operating Area



Part Number and Marking

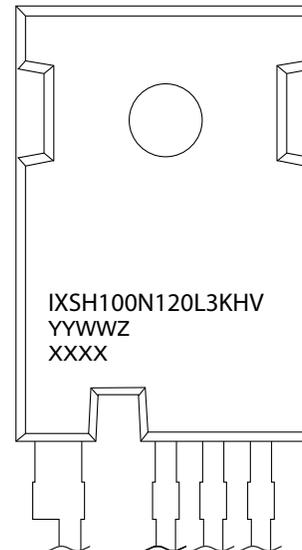
IXSH100N120L3KHV = Device Part Number

YY = Year

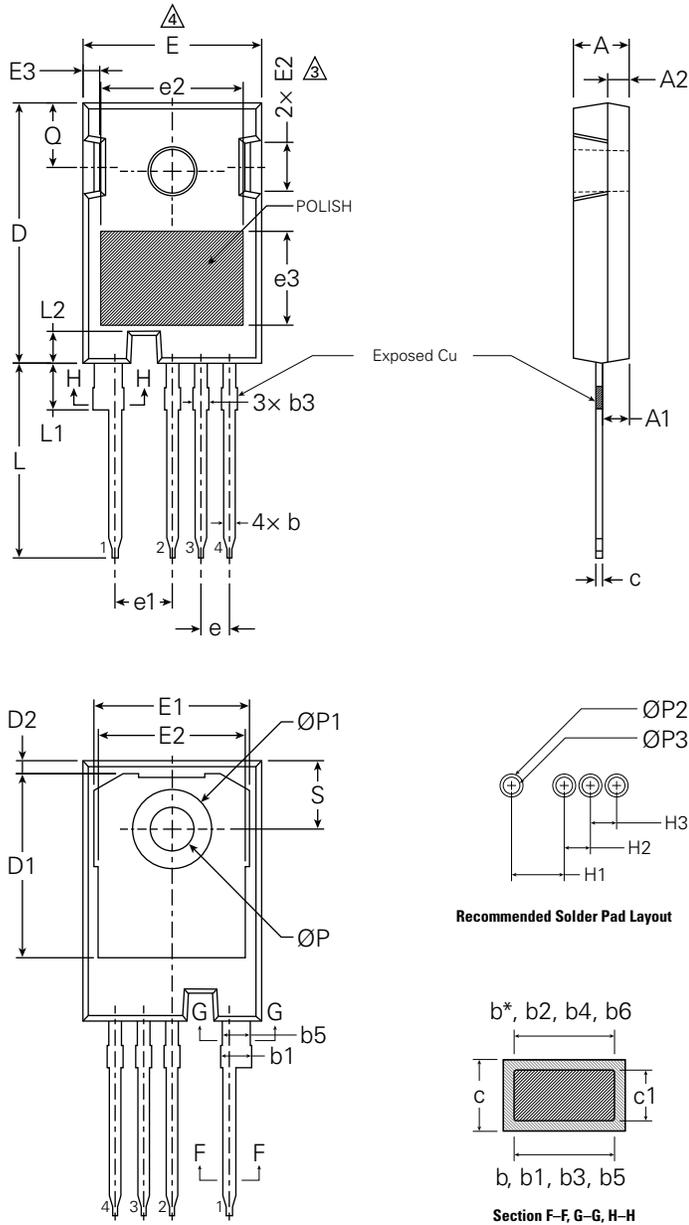
WW = Work Week

Z = Assembly Location

XXXX = Lot Traceability



Part Outline Drawing (TO-247-4L)



Note:

1. Package reference: JEDEC TO247, Variation AD
- △ Slot required, notch may be rounded
- △ Dimension D&E do not include mold flash
4. Subject to change without notice

Symbol	Inches			Millimeters		
	Min.	Typical	Max.	Min.	Typical	Max
A	0.190	-	0.205	4.83	-	5.21
A1	0.090	-	0.100	2.29	-	2.54
A2	0.075	-	0.085	1.91	-	2.16
b	0.042	-	0.052	1.07	-	1.33
b*	0.042	-	0.050	1.07	-	1.28
b1	0.094	-	0.116	2.39	-	2.94
b2	0.094	-	0.112	2.39	-	2.84
b3	0.042	-	0.063	1.07	-	1.60
b4	0.042	-	0.059	1.07	-	1.50
b5	0.094	-	0.106	2.39	-	2.69
b6	0.094	-	0.104	2.39	-	2.64
c	0.022	-	0.027	0.55	-	0.68
c1	0.022	-	0.026	0.55	-	0.65
D	0.917	-	0.929	23.30	-	23.60
D1	0.640	-	0.695	16.25	-	17.65
D2	0.037	-	0.049	0.95	-	1.25
E	0.620	-	0.635	15.75	-	16.13
E1	0.516	-	0.557	13.10	-	14.15
E2	0.145	-	0.201	3.68	-	5.10
E3	0.039	-	0.075	1.00	-	1.90
E4	0.487	-	0.529	12.38	-	13.43
e	0.100 BSC			2.54 BSC		
e1	0.200 BSC			5.08 BSC		
e2	-	0.500	-	-	12.70	-
e3	-	0.330	-	-	8.38	-
H1	-	0.200	-	-	5.08	-
H2	-	0.100	-	-	2.54	-
H3	-	0.100	-	-	2.54	-
L	0.681	-	0.702	17.31	-	17.82
L1	0.156	-	0.172	3.97	-	4.37
L2	0.093	-	0.104	2.35	-	2.65
ØP	0.138	-	0.144	3.51	-	3.65
ØP1	0.283 REF.			7.18 REF.		
ØP2	-	0.088	-	-	2.24	-
ØP3	-	0.067	-	-	1.70	-
Q	0.216	-	0.236	5.49	-	6.00
S	0.238	-	0.248	6.04	-	6.30

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Part of:

